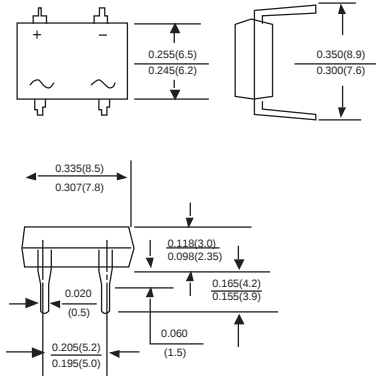


DB-1



Dimensions in inches and (millimeters)

FEATURES

- ◆ Ideal for printed circuit board
- ◆ Reliable low cost construction utilizing molded plastic technique
- ◆ High temperature soldering guaranteed: 250* / 10 seconds / 0.375"(9.5mm) led length at 5 lbs., (2.3kg)tension
- ◆ Small size, simple installation
Leads solderable per MIL-STD-202, Method 208
- ◆ High surge current capability

MECHANICAL DATA

Case: Molded plastic body

Terminals: Plated leads solderable per MIL-STD-750, Method 2026

Polarity: Polarity symbols marked on case

Mounting Position: Any

Weight: 0.011 ounce, 0.32 grams

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25* ambient temperature unless otherwise specified.

Single phase half-wave 60Hz, resistive or inductive load, For capacitive load derate current by 20%.

	SYMBOLS	DB 201	DB 202	DB 203	DB 204	DB 205	DB 206	DB 207	UNITS
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	VOLTS
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	VOLTS
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	VOLTS
Maximum average forward rectified current at $T_A=40^*$	$I_{F(AV)}$	2.0							Amps
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	60							Amps
Maximum instantaneous forward voltage drop per bridge element at 2.0A	V_F	1.1							Volts
Maximum DC reverse current $T_A=25^*$ at rated DC blocking voltage $T_A=125^*$	I_R	10 500							μA μA
Operating temperature range	T_J	-55 to +150							*
storage temperature range	T_{STG}	-55 to +150							*

NOTES: DBS for surface mount package.

